Near Field Communication (NFC) controller

1.3 Standards compliancy

PN533 offers commands in order for applications to be compliant in reader mode with "Paypass-ISO/IEC 14443 Implementation v1.1".

PN533 supports RF protocols ISO/IEC 14443A and B such as compliancy with Smart eID standard can be achieved at application level.

A dedicated command is implemented in PN533 firmware to support NFC secure applications in accordance with "NFC sec Security layer for NFC" specification in order to enable USB wireless or BT enabler applications in a host baseband.

2. Features and benefits

- 80C51 microcontroller core with 45056 bytes ROM and 1224 bytes RAM
- Highly integrated demodulator and decoder
- Buffered output drivers to connect an antenna with minimum number of external components
- Integrated RF level detector
- Integrated data mode detector
- Supports ISO/IEC 14443A Reader/Writer mode up to 848 kbit/s
- Supports ISO/IEC 14443B Reader/Writer mode up to 848 kbit/s
- Supports MIFARE encryption in Reader/Writer mode and higher transfer speed communication at 212 kbit/s, 424 kbit/s and 848kbit/s
- Supports contactless communication according to the FeliCa protocol at 212 kbit/s and 424 kbit/s
- Typical operating distance in Reader/Writer mode for communication to ISO/IEC 14443A/MIFARE, ISO/IEC 14443B or FeliCa cards up to 50 mm depending on antenna size and tuning
- Support NFCIP-1 mode up to 424 kbit/s
- Typical operating distance in NFCIP-1 mode up to 50 mm depending on antenna size, tuning and power supply
- Supported USB 2.0 full speed interface
- Restricted I²C master interface to control an external I²C EEPROM or TDA8029 smart card reader
- Low-power modes
 - Hard-Power-Down mode
 - Soft-Power-Down mode
- 27.12 MHz Crystal oscillator
- On-Chip PLL to generate internally 96 MHz for the USB interface
- Power modes
 - USB bus power mode
 - ◆ 2.5 V to 3.6 V power supply operating range in non-USB bus power mode
- Dedicated IO ports for external device control

PN533_SDS

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Near Field Communication (NFC) controller

3. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{BUS}	bus supply voltage		4.02	5	5.25	V
		(non-USB mode); $V_{BUS} = V_{DDD}$; $V_{SSD} = 0 \text{ V}$	2.5	3.3	3.6	V
V_{DDA}	analog supply voltage	$V_{DDA} = V_{DDD} = V_{DD(TVDD)} = V_{DD(PVDD)}; V_{SSA} = V_{SSD} = V_{SS(PVSS)} = V_{SS(TVSS)} = 0 V$	<u>[1]</u> 2.5	3.3	3.6	V
V_{DDD}	digital supply voltage		<u>[1]</u> 2.5	3.3	3.6	V
$V_{DD(TVDD)}$	TVDD supply voltage	VSS(PVSS) - VSS(TVSS) - VV	<u>[1]</u> 2.5	3.3	3.6	V
$V_{DD(PVDD)}$	PVDD supply voltage		1.6	-	3.6	V
V _{DD(SVDD)}	SVDD supply voltage	$V_{SSA} = V_{SSD} = V_{SS(PVSS)} = V_{SS(TVSS)} = 0 \text{ V}$; reserved for future use	V _{DDD} –	0.1 -	V_{DDD}	V
I _{BUS}	bus supply current	maximum load current (USB mode); measured on V_{BUS}			150	mA
		maximum inrush current limitation; at power-up (curlimoff = 0)			100	mA
I _{pd}	power-down current	$V_{DDA} = V_{DDD} = V_{DD(TVDD)} = V_{DD(PVDD)} = 3 \text{ V}$; not powered from USB				
		hard power-down; RF level detector off			10	μА
		soft power-down; RF level detector on			30	μΑ
I _{CCSL}	suspended low-power device supply current	RF level detector on, (without resistor on DP/DM)	[1] -	-	250	μΑ
I _{DDD}	digital supply current	RF level detector on, V _{DD(SVDD)} switch off	<u>[1]</u> _	15	-	mA
I _{DD(SVDD)}	SVDD supply current	$V_{DDS} = 3 V$	-	-	30	mA
I _{DDA}	analog supply current	RF level detector on	-	6	-	mA
$I_{DD(TVDD)}$	TVDD supply current	during RF transmission; $V_{DD(TVDD)} = 3 \text{ V}$	-	60	100	mA
P _{tot}	total power dissipation	$T_{amb} = -30 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$	-	-	0.55	W
T _{amb}	ambient temperature		-30	-	+85	°C

^[1] V_{DDD} , V_{DDA} and $V_{DD(TVDD)}$ must always be at the same supply voltage.

4. Ordering information

Table 2. Ordering information

Type number	Package			
	Name	Description	Version	
PN5331B3HN/C270[1][2]	HVQFN40	plastic thermal enhanced very thin quad flat package; no leads; 40 terminals; body 6 x 6 x 0.85 mm	SOT618-1	

^{[1] 70} refers to the ROM code version described in User Manual.

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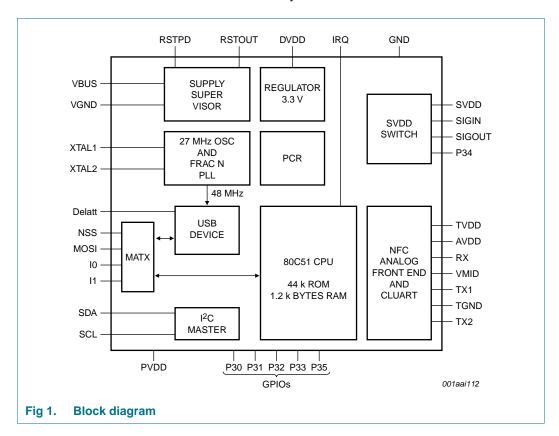
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^[2] Refer to Section 9.4 "Licenses"

Near Field Communication (NFC) controller

5. Block diagram

The following block diagram describes hardware blocks controlled by PN533 firmware or which can be accessible for data transaction by a host baseband.



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Near Field Communication (NFC) controller

6. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DDA}	analog supply voltage		-0.5	+4	V
V_{DDD}	digital supply voltage		-0.5	+4	V
$V_{DD(TVDD)}$	TVDD supply voltage		-0.5	+4	V
$V_{DD(PVDD)}$	PVDD supply voltage		-0.5	+4	V
V _{DD(SVDD)}	SVDD supply voltage		-0.5	+4	V
V_{BUS}	bus supply voltage		-0.5	+5.5	V
P _{tot}	total power dissipation		-	500	mW
$I_{DD(SVDD)}$	SVDD supply current	maximum current in V _{DDS} switch	-	30	mA
Vi	input voltage	TX1, TX2, RX pins	-0.5	+4	V
V _{ESD}	electrostatic discharge voltage	HBM	<u>[1]</u>	±2.0	kV
		MM	[2] -	200	V
		CDM	[3] _	±1	kV
T _{stg}	storage temperature		–55	+150	°C
Tj	junction temperature		-40	+125	°C

^[1] 1500Ω , 100 pF; EIA/JESD22-A114-A

7. Abbreviations

Table 4. Abbreviations

	Description
CDM	Charge Device Model
CRC	Cyclic Redundancy Check
EEPROM	Electrically Erasable Programmable Read-Only Memory
НВМ	Human Body Model
HPD	Hard Power Down
MM	Machine Model
NFC	Near Field Communication
SPD	Soft Power-Down Mode

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^{[2] 0.75} mH, 200 pF; EIA/JESD22-A115-A

^[3] Field induced model; EIA/JESC22-C101-C

Near Field Communication (NFC) controller

8. Revision history

Table 5. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PN533_SDS v.3.3	20120716	Product short data sheet	-	PN533_SDS v.3.2
Modifications:	Section 9.4 "Lice	nses": updated		
PN533_SDS v.3.2	20120202	Product short data sheet	-	PN5331B3HN_ SDS_N_1
Modifications:	 Section 1 "G 	eneral description": updated		
PN5331B3HN_SDS_N_1	20081231	Product short data sheet PUBLIC	-	-

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Near Field Communication (NFC) controller

9. Legal information

9.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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PN533 NXP Semiconductors

Near Field Communication (NFC) controller

11. Contents

1	General description
1.1	RF protocols
1.2	Interfaces
1.3	Standards compliancy 2
2	Features and benefits 2
3	Quick reference data 3
4	Ordering information 3
5	Block diagram 4
6	Limiting values 5
7	Abbreviations 5
8	Revision history 6
9	Legal information 7
9.1	Data sheet status
9.2	Definitions
9.3	Disclaimers
9.4	Licenses
9.5	Trademarks 8
10	Contact information 8
11	Contents

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